74LVT125; 74LVTH125

3.3 V quad buffer; 3-state

Rev. 7 — 31 May 2016

Product data sheet

1. **General description**

The 74LVT125; 74LVTH125 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3 V.

This device combines low static and dynamic power dissipation with high speed and high output drive. The 74LVT125; 74LVTH125 device is a quad buffer that is ideal for driving bus lines. The device features four output enable inputs (1OE, 2OE, 3OE and 4OE), each controlling one of the 3-state outputs.

Features and benefits 2.

- Quad bus interface
- 3-state buffers
- Output capability: +64 mA and -32 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- Latch-up protection:
 - JESD78: exceeds 500 mA
- ESD protection:
 - MIL STD 883 method 3015; exceeds 2000 V
 - Machine model: exceeds 200 V

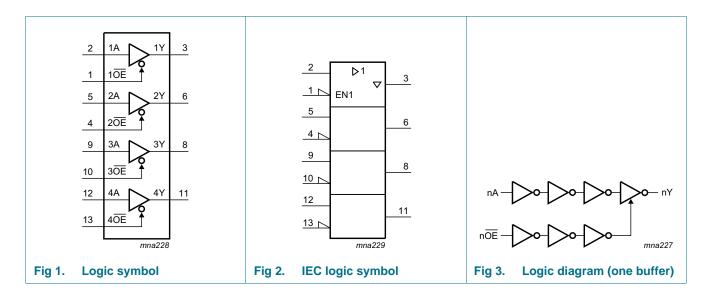


3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | |
|-------------|-------------------|----------|--|----------|--|
| | Temperature range | Name | Description | Version | |
| 74LVT125D | –40 °C to +85 °C | SO14 | plastic small outline package; 14 leads; | SOT108-1 | |
| 74LVTH125D | | | body width 3.9 mm | | |
| 74LVT125DB | −40 °C to +85 °C | SSOP14 | plastic shrink small outline package; 14 leads; | SOT337-1 | |
| 74LVTH125DB | | | body width 5.3 mm | | |
| 74LVT125PW | –40 °C to +85 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; | SOT402-1 | |
| 74LVTH125PW | | | body width 4.4 mm | | |
| 74LVT125BQ | –40 °C to +85 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very | SOT762-1 | |
| 74LVTH125BQ | | | thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | | |

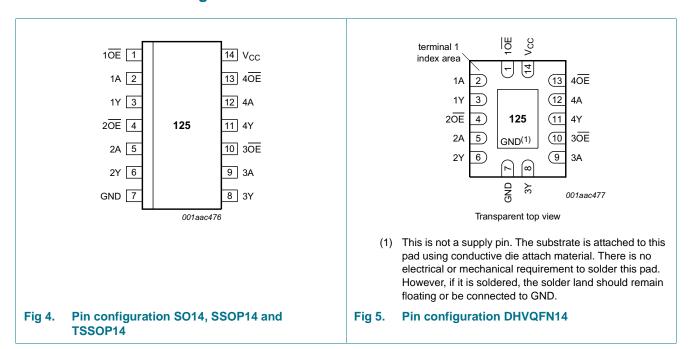
4. Functional diagram



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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|-----|------------------------------------|
| 1 OE | 1 | 1 output enable input (active LOW) |
| 1A | 2 | 1 data input |
| 1Y | 3 | 1 data output |
| 2 OE | 4 | 2 output enable input (active LOW) |
| 2A | 5 | 2 data input |
| 2Y | 6 | 2 data output |
| GND | 7 | ground (0 V) |
| 3Y | 8 | 3 data output |
| 3A | 9 | 3 data input |
| 3 OE | 10 | 3 output enable input (active LOW) |
| 4Y | 11 | 4 data output |
| 4A | 12 | 4 data input |
| 4 OE | 13 | 4 output enable input (active LOW) |
| V _{CC} | 14 | supply voltage |

6. Functional description

6.1 Function table

Table 3. Function table[1]

| Control | Input | Output |
|---------|-------|--------|
| nOE | nA | nY |
| L | L | L |
| L | Н | Н |
| Н | X | Z |

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|-----------------------------------|------------|------|------|------|
| V _{CC} | supply voltage | | | -0.5 | +4.6 | V |
| V _I | input voltage | | <u>[1]</u> | -0.5 | +7.0 | V |
| Vo | output voltage | output in OFF-state or HIGH-state | <u>[1]</u> | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < 0 V | | - | -50 | mA |
| I _{OK} | output clamping current | V _O < 0 V | | - | -50 | mA |
| Io | output current | output in LOW-state | | - | 128 | mA |
| | | output in HIGH-state | | - | -64 | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| Tj | junction temperature | | [2] | - | 150 | °C |

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------------|--|-----|-----|-----|------|
| V _{CC} | supply voltage | | 2.7 | - | 3.6 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| I _{OH} | HIGH-level output current | | - | - | -32 | mA |
| I _{OL} | LOW-level output current | none | - | - | 32 | mA |
| | | current duty cycle \leq 50 %; $f \geq$ 1 kHz | - | - | 64 | mA |
| Δt/ΔV | input transition rise and fall rate | | 0 | - | 10 | ns/V |
| T _{amb} | ambient temperature | in free air | -40 | - | +85 | °C |

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^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---|--|---|-----|-----------------------|-----------------------|------|------|
| T _{amb} = - | 40 °C to +85 °C[1] | | | ' | | | |
| V _{IK} | input clamping voltage | $I_{IK} = -18 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | | - | -0.9 | -1.2 | V |
| V _{OH} | HIGH-level output voltage | $I_{OH} = -100 \mu A;$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | | V _{CC} - 0.2 | V _{CC} – 0.1 | - | V |
| | | $I_{OH} = -8 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | | 2.4 | 2.5 | - | V |
| | | $I_{OH} = -32 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | | 2.0 | 2.2 | - | V |
| V _{OL} | LOW-level output voltage | V _{CC} = 2.7 V | | | | | |
| | | I _{OL} = 100 μA | | - | 0.1 | 0.2 | V |
| | | I _{OL} = 24 mA | | - | 0.3 | 0.5 | V |
| | | V _{CC} = 3.0 V | | | | | |
| V _{OL} LC I _I inp I _{OFF} po I _{BHL} bu I _{BHH} bu I _{BHLO} bu ov I _{BHHO} bu ov | | I _{OL} = 16 mA | | - | 0.25 | 0.4 | V |
| | | I _{OL} = 32 mA | | - | 0.3 | 0.5 | V |
| | input clamping voltage HIGH-level output voltage LOW-level output voltage input leakage current input leakage current power-off leakage current bus hold LOW current bus hold HIGH current bus hold LOW overdrive current bus hold HIGH overdrive current output leakage current power-up/power-down output current power-up/power-down output current | I _{OL} = 64 mA | | - | 0.4 | 0.55 | V |
| l _l | input leakage current | all input pins | | | | | |
| | | $V_{CC} = 0 \text{ V or } 3.6 \text{ V; } V_{I} = 5.5 \text{ V}$ | | - | 1 | 10 | μΑ |
| | | control pins | | | | | |
| | | $V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}$ | | - | ±0.1 | ±1 | μΑ |
| | | data pins | [2] | | | | |
| | | $V_{CC} = 3.6 \text{ V}; V_{I} = V_{CC}$ | | - | 0.1 | 1 | μΑ |
| | | $V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V}$ | | - | -1 | -5 | μΑ |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}$; $V_I \text{ or } V_O = 0 \text{ V to } 4.5 \text{ V}$ | | - | 1 | ±100 | μΑ |
| I _{BHL} | bus hold LOW current | V _{CC} = 3 V; V _I = 0.8 V | [3] | 75 | 150 | - | μΑ |
| I _{внн} | bus hold HIGH current | V _{CC} = 3 V; V _I = 2.0 V | | - | -150 | -75 | μΑ |
| I _{BHLO} | | $V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$ | | 500 | - | - | μА |
| Івнно | | $V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$ | | - | - | -500 | μА |
| LO | output leakage current | output in HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 \text{ V}$; $V_{CC} = 3.0 \text{ V}$ | | - | 60 | 125 | μА |
| O(pu/pd) | 1 | $V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_L = \text{GND or } V_{CC};$ nOE = don't care | [4] | - | ±1 | ±100 | μА |
| loz | OFF-state output current | $V_{CC} = 3.6 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}$ | | | | | |
| | | output HIGH: V _O = 3.0 V | | - | 1 | 5 | μΑ |
| | | output LOW: V _O = 0.5 V | | - | -1 | -5 | μΑ |

Table 6. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|------------------|---------------------------|---|-----|------|------|------|------|
| I _{CC} | supply current | $V_{CC} = 3.6 \text{ V}; V_I = \text{GND or } V_{CC};$ $I_O = 0 \text{ A}$ | | | | | |
| | | outputs HIGH | - | 0.13 | 0.19 | mA | |
| | | outputs LOW | - | 2 | 7 | mA | |
| | | outputs disabled | [5] | - | 0.13 | 0.19 | mA |
| Δl _{CC} | additional supply current | per input pin; V_{CC} = 3 V to 3.6 V; one input at V_{CC} – 0.6 V and other inputs at V_{CC} or GND | [6] | - | 0.1 | 0.2 | mA |
| Cı | input capacitance | V _I = 0 V or 3.0 V | | - | 4 | - | pF |
| Co | output capacitance | outputs disabled; V _O = 0 V or 3.0 V | | - | 8 | - | pF |

- [1] Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.
- [2] Unused pins at V_{CC} or GND.
- [3] This is the bus hold overdrive current required to force the input to the opposite logic state.
- This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.0 V to 3.6 V a transition time of 100 μ s is permitted. This parameter is valid for T_{amb} = 25 °C only.
- [5] I_{CC} is measured with outputs pulled to V_{CC} or GND.
- [6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-------------------------------------|--|-----|-----|------------------------|------|
| T _{amb} = - | 40 °C to +85 °C[1] | | | | | |
| t _{PLH} | LOW to HIGH propagation delay | nAn to nY; see Figure 6 | | | | |
| | | V _{CC} = 2.7 V | - | - | 4.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.7 | 4.0 | ns |
| t _{PHL} | HIGH to LOW propagation delay | nAn to nY; see Figure 6 | | | | |
| | | V _{CC} = 2.7 V | - | - | 4.9 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.9 | 2.9 3.9 ns - 6.0 ns | |
| t _{PZH} | OFF-state to HIGH propagation delay | nOE to nY; see Figure 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 6.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 3.4 | 4.7 | ns |
| t _{PZL} | OFF-state to LOW propagation delay | nOE to nY; see Figure 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 6.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.1 | 3.4 | 4.7 | ns |
| t _{PHZ} | HIGH to OFF-state propagation delay | nOE to nY; see Figure 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 5.7 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.8 | 3.7 | 5.1 | ns |

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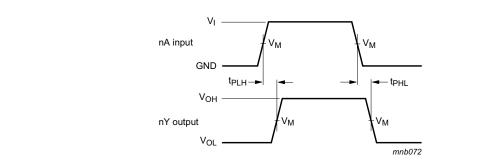
 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|------------------------------------|----------------------------------|-----|-----|-----|------|
| t _{PLZ} | LOW to OFF-state propagation delay | nOE to nY; see Figure 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 4.0 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.3 | 2.6 | 4.5 | ns |

[1] Typical values are at $V_{CC} = 3.3 \text{ V}$ and $T_{amb} = 25 \,^{\circ}\text{C}$.

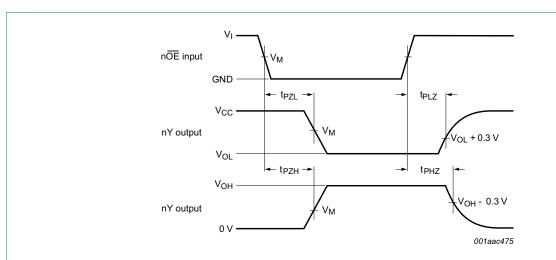
11. Waveforms



 $V_{M} = 1.5 V.$

 $\ensuremath{V_{OL}}$ and $\ensuremath{V_{OH}}$ are typical voltage output levels that occur with the output load.

Fig 6. Propagation delay input (nA) to output (nY)



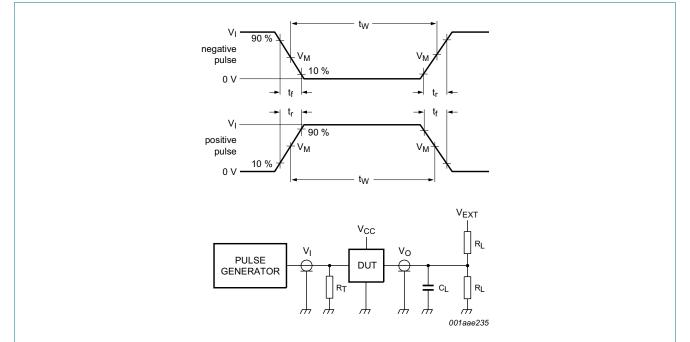
 $V_{M} = 1.5 V.$

 $\ensuremath{V_{OL}}$ and $\ensuremath{V_{OH}}$ are typical voltage output levels that occur with the output load.

Fig 7. Enable and disable times of 3-state outputs

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Test data is given in Table 8.

Definitions test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = Test voltage for switching times.

Fig 8. Test circuit for measuring switching times

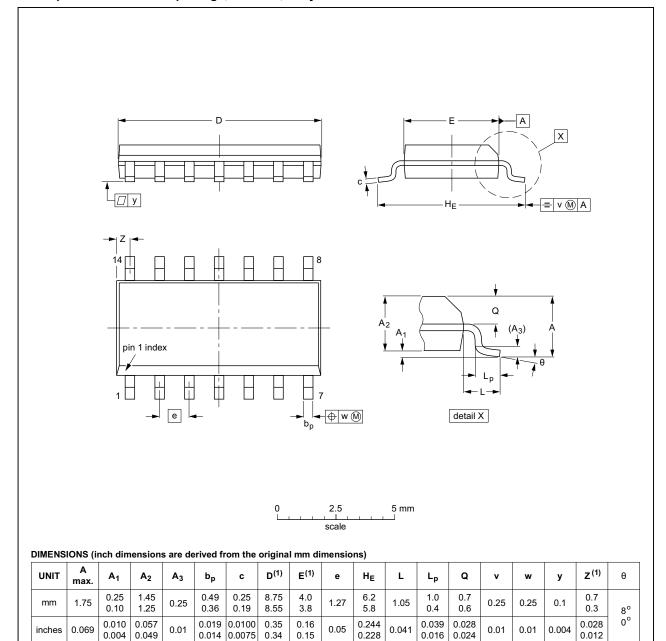
Table 8. Test data

| Input | | | | Load | | V _{EXT} | | | |
|----------------|--|--------|---------------------------------|-------|--------------|---|-----|-------------------------------------|--|
| V _I | f _i t _W t _r , | | t _r , t _f | CL | R_L | t _{PHZ} , t _{PZH} t _{PLZ} , t _{PZL} | | t _{PLH} , t _{PHL} | |
| 2.7 V | ≤ 10 MHz | 500 ns | ≤ 2.5 ns | 50 pF | 500Ω | GND | 6 V | open | |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

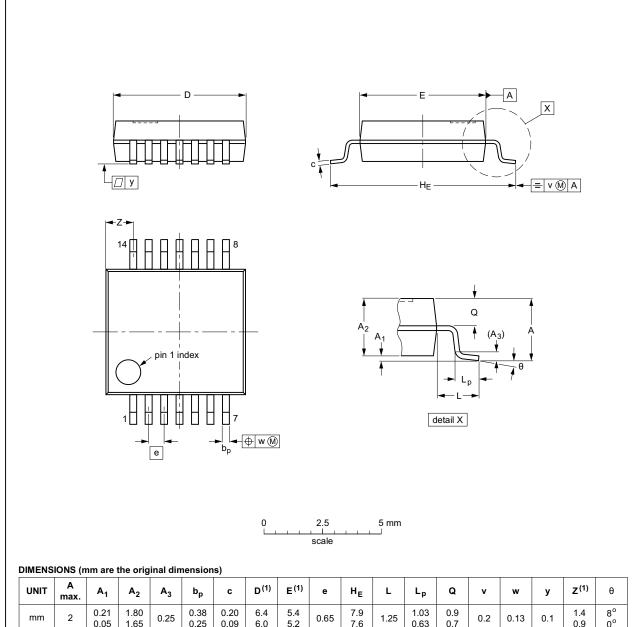
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT108-1 | 076E06 | MS-012 | | | | 99-12-27 03-02-19 |

Fig 9. Package outline SOT108-1 (SO14)

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | C | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | > | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|-----------------------|----------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.4 0.9 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

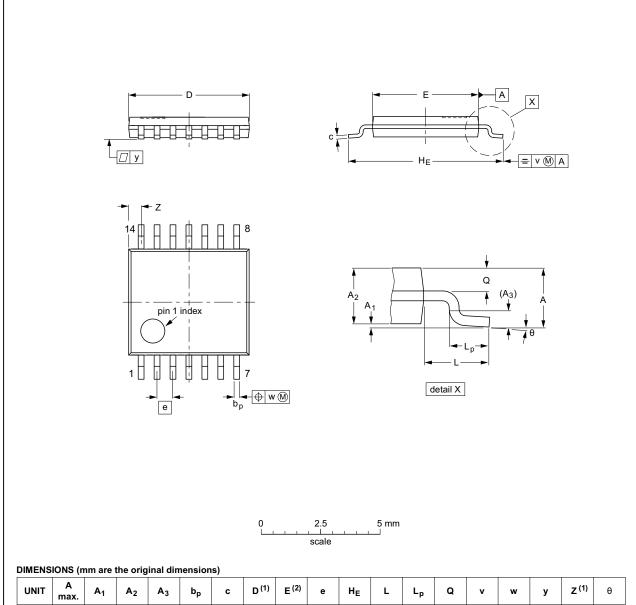
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT337-1 | | MO-150 | | | | 99-12-27 03-02-19 | |

Fig 10. Package outline SOT337-1 (SSOP14)

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | C | D ⁽¹⁾ | E (2) | е | HE | L | Lp | Q | > | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|-----------------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.72 0.38 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|----------|-----|--------|----------|------------|------------|---------------------------------|
| | VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| | SOT402-1 | | MO-153 | | | | 99-12-27 03-02-18 |

Fig 11. Package outline SOT402-1 (TSSOP14)

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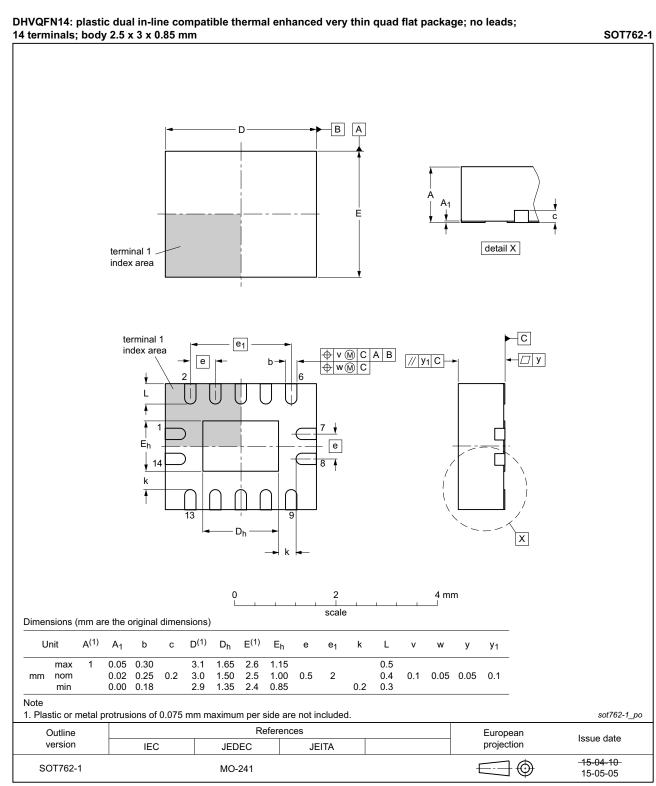


Fig 12. Package outline SOT762-1 (DHVQFN14)

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13. Abbreviations

Table 9. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | | | | |
|-------------------|-----------------------------------|---|---|-----------------|--|--|--|--|--|
| 74LVT_LVTH125 v.7 | 20160531 | Product data sheet | - | 74LVT125 v.6 | | | | | |
| Modifications: | | of this data sheet has been ref NXP Semiconductors. | this data sheet has been redesigned to comply with the new identity NXP Semiconductors. | | | | | | |
| | Legal texts h | nave been adapted to the ne | ew company name where | e appropriate. | | | | | |
| 74LVT_LVTH125 v.6 | 20060306 | Product data sheet | - | 74LVT125 v.5 | | | | | |
| Modifications: | • <u>Section 3</u> : A 74LVTH125 | dded type numbers 74LVTH BQ. | 1125D, 74LVTH125DB, 7 | 74LVTH125PW and | | | | | |
| 74LVT125 v.5 | 20050210 | Product data sheet | - | 74LVT125 v.4 | | | | | |
| 74LVT125 v.4 | 20050207 | Product data sheet | - | 74LVT125 v.3 | | | | | |
| 74LVT125 v.3 | 20040624 | Product data sheet | - | 74LVT125 v.2 | | | | | |
| 74LVT125 v.2 | 19980219 | Product specification | - | 74LVT125 v.1 | | | | | |
| 74LVT125 v.1 | - | - | - | - | | | | | |

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15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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